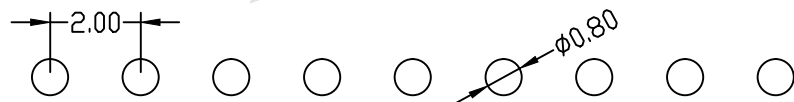
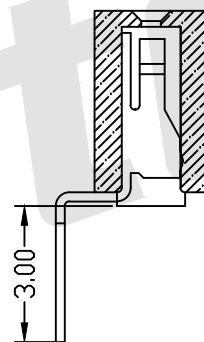
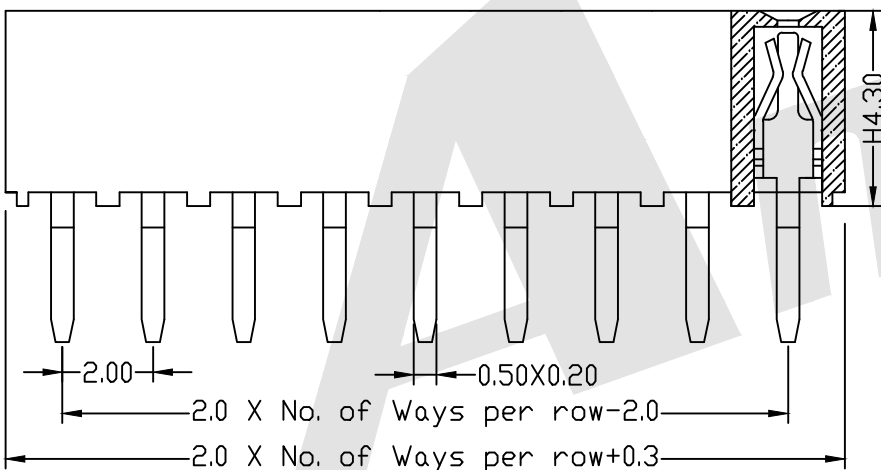
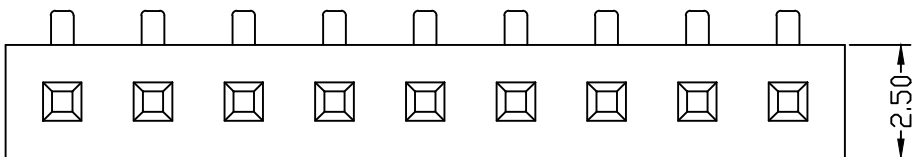


HSF



PCB LAYOUT

SPECIFICATION

Current Rating:	1.5Amp
Insulation Resistance:	1000M ohms min
Contact Resistance:	20M ohms max
Dielectric Withstanding:	AC500V
Operating Temperature:	-65°C to +125°C
Contact Material:	Brass
Insulator Material:	PA6T UL 94V-0 Black

Ordering Code:

FH DU01 - X - X - S - X - X - X
① ② ③ ④ ⑤ ⑥ ⑦

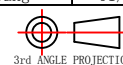
- ① Series No:
② No. of Contacts
01 To 40
③ Contact Plating:
G0:Gold flash S0:Selective
G1:3U" Gold S1:Selective 3u"
G2:5u" Gold S2:Selective 5u"
G3:10u" Gold S3:Selective 10u"
G4:15u" Gold S4:Selective 15u"
G5:30u" Gold S5:Selective 30u"
SN:Tin
④ Connector Type
S:Single
⑤ Plastic High:
H:4.3
Please mark the desired length in the H
- ⑥ Insulator Material
B:PA6T
C:LCP
D:PA46
E:PA9T
⑦ Packing
A:Tray
B:Bag
T:Tube
U:Tube+CAP
R:Tape&Reel
W:Tape&Reel+CAP

Unless Otherwise specified tolerance

X. XX: ±0.20
X. X: ±0.25 X. XXX: ±0.15

SCALE: As Shown UNIT: mm

DRAW YG ZHONG DATE 01/05/2016
CHECK BobYang DATE 01/05/2016



ANTENK ELECTRONICS CO., LTD
Http://www.antenk.com
E-mail:sales@antenk.com

TITLE: 2.00mm Female Header
Single Row Bottom Entry Type1

DRAWING NO: FH DU01-XXSXXX

PRODUCT NO: FH DU01-XXSXXX

REV

DESCRIPTION

DATE